### DESCRIPTION

The SPP7001K is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

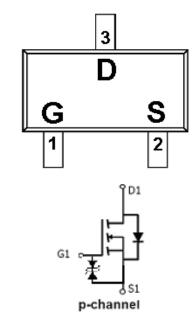
#### APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

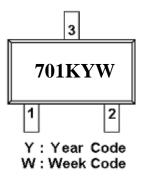
#### FEATURES

- -60V/-0.5A, RDS(ON)=  $6\Omega@VGS=-10V$
- -60V/-0.25A, RDS(ON)=  $10\Omega@VGS=-4.5V$
- Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ◆ SOT-23 package design

### PIN CONFIGURATION(SOT-23)



### PART MARKING





PIN DESCRIPTION					
Pin	Symbol	Description			
1	G	Gate			
2	S	Source			
3	D	Drain			

### ORDERING INFORMATION

Part Number	Package	Part Marking
SPP7001KS23RGB	SOT-23	701KYW

<sup>★</sup> Week Code : A ~ Z(1 ~ 26); a ~ z(27 ~ 52)

\* SPP7001KS23RGB : Tape Reel ; Pb – Free; Halogen – Free

### ABSOULTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit	
Drain-Source Voltage		Vdss	-60	V
Gate –Source Voltage		VGSS	±20	V
	TA=25°C	T_	-0.5	•
Continuous Drain Current(TJ=150°C)	Ta=70°C	- Id	-0.3	A
Pulsed Drain Current	Ідм	-1	А	
Continuous Source Current(Diode Conduction)		Is	-0.5	А
Description	TA=25°C		1.25	W
Power Dissipation	Ta=70°C	- Pd	0.8	W
Operating Junction Temperature		Тл	150	°C
Storage Temperature Range		Tstg	-55/150	°C
Thermal Resistance-Junction to Ambient		Rөја	375	°C/W

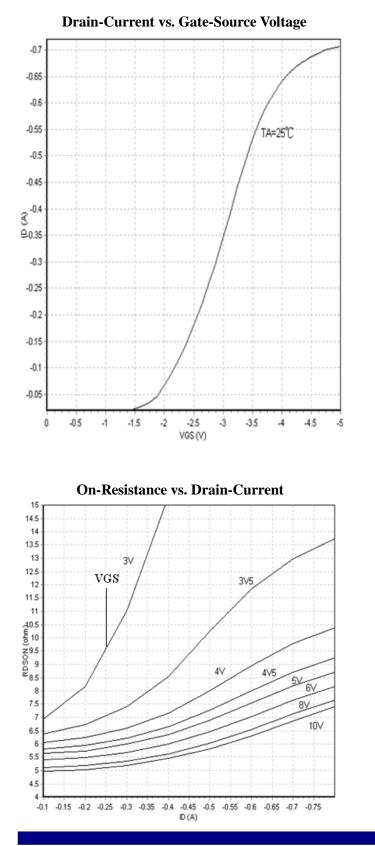


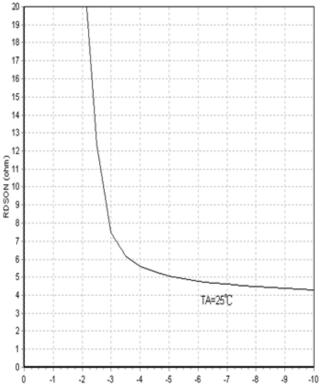
### ELECTRICAL CHARACTERISTICS

(TA= $25^{\circ}$ C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static						-	
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V,ID=-250uA	-60			v	
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=-250uA	-1		-3	V	
Gate Leakage Current	Igss	VDS=0V,VGS=±20V			±10	uA	
		VDS=-60V,VGS=0V			-1	uА	
Zero Gate Voltage Drain Current	IDSS	VDS=-60V,VGS=0V TJ=55°C			-10		
On-State Drain Current	ID(on)	$V_{DS} \leq -5V, V_{GS} = -10V$	-1			А	
Drain-Source On-Resistance	RDS(on)	Vgs=- 10V,Id=-0.5A			6	Ω	
Dram-Source On-Resistance		VGS=-4.5V,ID=-0.25A			10		
Forward Transconductance	gfs	Vds=-10V,Id=-0.5A		1		S	
Diode Forward Voltage	Vsd	Is=-0.2A,VGs=0V			-1.5	V	
Dynamic							
Total Gate Charge	Qg			2		nC	
Gate-Source Charge	Qgs	$V_{DS}=-30V, V_{GS}=-15V$ ID= -0.5A		0.53			
Gate-Drain Charge	Qgd	-ID0.3A		0.72			
Input Capacitance	Ciss			25		pF	
Output Capacitance	Coss	VDS=-25V,VGS=0V f=1MHz		13			
Reverse Transfer Capacitance	Crss	-1-11v111Z		7.3			
Turn-On Time	td(on)	VDD=-25V, ID=-200mA,		20		nS	
Turn-Off Time	td(off)	Vgen=-10V		35			

### TYPICAL CHARACTERISTICS

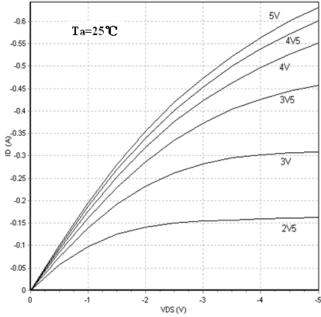




### **On-Resistance vs. Gate-Source Voilage**

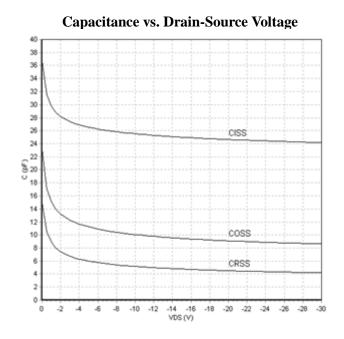
Drain-Source Current vs. Drain-Source Voltage

VGS (V)

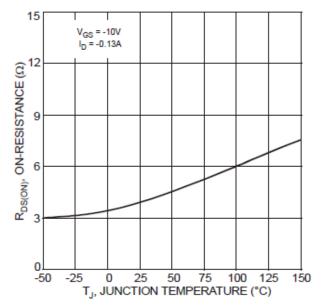


2015/04/20 Ver.1

### **TYPICAL CHARACTERISTICS**

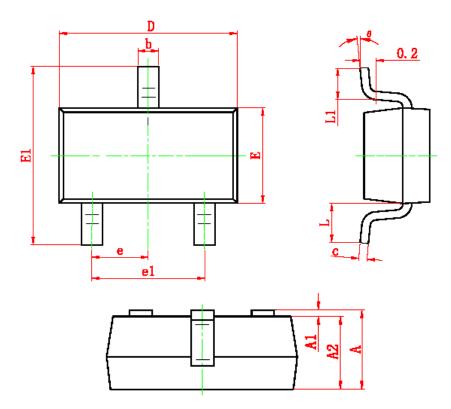


**On-Resistance vs. Drain-Current** 





### SOT-23 PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
A	0.900	1.200	0.035	0.043	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.100	0.035	0.039	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037	7 TYP	
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022	2 REF	
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	6°	



Information provided is alleged to be exact and consistent. SYNC Power Corporation presumes no responsibility for the penalties of use of such information or for any violation of patents or other rights of third parties which may result from its use. No license is granted by allegation or otherwise under any patent or patent rights of SYNC Power Corporation. Conditions mentioned in this publication are subject to change without notice. This publication surpasses and replaces all information previously supplied. SYNC Power Corporation products are not authorized for use as critical components in life support devices or systems without express written approval of SYNC Power Corporation.

© The SYNC Power logo is a registered trademark of SYNC Power Corporation © 2014 SYNC Power Corporation – Printed in Taiwan – All Rights Reserved SYNC Power Corporation 7F-2, No.3-1, Park Street NanKang District (NKSP), Taipei, Taiwan 115 Phone: 886-2-2655-8178 Fax: 886-2-2655-8468 © http://www.syncpower.com